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NOTES: UNLESS OTHERWISE SPECIFIED

1. ASSEMBLY HOUSE TO VISUALLY VERIFY BOARD BEING ASSEMBLED HAS ALTERA P/N 100-0320611-B1 REV B IN ETCH ON BOTTOM SIDE.
2. ASSEMBLE BOARD PER IPC-A-610(LATEST REVISION) STANDARD.
3. ALL MATERIALS USED MUST BE ROHS COMPLIANT.
4. HANDLE MOISTURE SENSITIVE DEVICES(MSD) PER MANUFACTURE'S CALL OUT ON MSD LABEL. IF MSD LABEL IS MISSING OR NOT LEGIBLE THEN ALL PLASTIC PACKAGED COMPONENTS ARE TO BE CONSIDERED MSD LEVEL 6 AND USE EIA/JEP 113-A FOR HANDLING.
5. REWORK MUST BE APPROVED BY CUSTOMER BEFORE BEING ACCEPTIBLE USE IPC-R-700(LATEST REVISION) FOR ALL PCA REWORK APPROVED.
6. SQUARE PIN PAD DENOTE PIN 1 OF ICs/CONNECTORS. POSITIVE END FOR CAPACITORS OR CATHODE END FOR DIODES.
7. INSTALL BAR CODE LABEL APPROX WHERE SHOWN, INCLUDING S/N.

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REV	DESCRIPTION	DATE	APPROVED

DWG NO: 130-0320611-B1

REV: B

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